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#### December 2014

## FGA30T65SHD 650 V, 30 A Field Stop Trench IGBT

#### Features

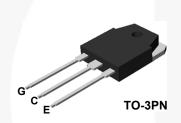
- Maximum Junction Temperature : T<sub>J</sub> =175<sup>o</sup>C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V<sub>CE(sat)</sub> =1.6 V(Typ.) @ I<sub>C</sub> = 30 A
- + 100% of the Parts Tested for  $I_{LM}(1)$
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- · RoHS Compliant

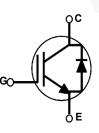
### **General Description**

Using novel field stop IGBT technology, Fairchild's new series of field stop 3<sup>rd</sup> generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

#### Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Description		FGA30T65SHD	Unit
V <sub>CES</sub>	Collector to Emitter Voltage		650	V
M	Gate to Emitter Voltage		± 20	V
V <sub>GES</sub>	Transient Gate to Emitter Voltage		± 30	V
	Collector Current	@ T <sub>C</sub> = 25°C	60	A
I <sup>C</sup>	Collector Current	@ T <sub>C</sub> = 100°C	30	A
I <sub>LM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	90	А
I <sub>CM (2)</sub>	Pulsed Collector Current		90	А
IF	Diode Forward Current	@ T <sub>C</sub> = 25°C	40	А
'F	Diode Forward Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	20	А
I <sub>FM (2)</sub>	Pulsed Diode Maximum Forward Curr	90	А	
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	238	W
I D	Maximum Power Dissipation $@ T_C = 100^{\circ}C$		119	W
TJ	Operating Junction Temperature		-55 to +175	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 second	ls	300	°C

#### Notes:

1. V\_{CC} = 400 V, V\_{GE} = 15 V, I\_C =90 A, R\_G = 30  $\Omega,$  Inductive Load

2. Repetitive rating: Pulse width limited by max. junction temperature

## Thermal Characteristics

Symbol	Parameter	FGA30T65SHD	Unit		
R <sub>0JC</sub> (IGBT)	Thermal Resistance, Junction to Case, Max.	0.63	°C/W		
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	1.71	°C/W		
R <sub>θJA</sub>	Thermal Resistance, Junction to Ambient, Max.	40	°C/W		

## Package Marking and Ordering Information

Part Number	Top Mark	Package	Packaging Method	Reel Size	Tape Width	Quantity	
FGA30T65SHD	FGA30T65SHD	TO-3PN	Tube	-	-	30	

## Electrical Characteristics of the IGBT T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	toristics					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 1 \text{ mA}$	650	-	-	V
	Temperature Coefficient of Breakdown	V <sub>GE</sub> = 00, I <sub>C</sub> = 1 IIIA	050	-	-	v
ΔBV <sub>CES /</sub> ΔT <sub>J</sub>	Voltage	$I_{\rm C}$ = 1 mA, Reference to 25°C	-	0.6	-	V/ºC
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	I <sub>C</sub> = 30 mA, V <sub>CE</sub> = V <sub>GE</sub>	4.0	5.5	7.5	V
- (- /		I <sub>C</sub> = 30 A, V <sub>GE</sub> = 15 V	-	1.6	2.1	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_{\rm C}$ = 30 A, V <sub>GE</sub> = 15 V, T <sub>C</sub> = 175°C	-	2.14	-	V
Dynamic C	characteristics					
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V,	-	1558	-	pF
C <sub>oes</sub>	Output Capacitance		-	64	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance	f = 1MHz	-	19	-	pF
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time		-	14.4	-	ns
t <sub>r</sub>	Rise Time		-	16	- /	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 30 A,	-	52.8	-	ns
t <sub>f</sub>	Fall Time	R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,	-	9.6	-	ns
E <sub>on</sub>	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$	-	598	- 1	uJ
E <sub>off</sub>	Turn-Off Switching Loss		-	167	-	uJ
E <sub>ts</sub>	Total Switching Loss		-	765	-	uJ
t <sub>d(on)</sub>	Turn-On Delay Time		-	14.4	-	ns
t <sub>r</sub>	Rise Time	1	-	19.2	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 30 A,	-	59.2	-	ns
t <sub>f</sub>	Fall Time	R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,	-	8	-	ns
Eon	Turn-On Switching Loss	Inductive Load, T <sub>C</sub> = 175 <sup>o</sup> C	-	992	-	uJ
E .	Turn-Off Switching Loss	]	-	303	_	uJ
E <sub>off</sub>	1 ann an anna 19 2000					

## Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 30 A, V <sub>GE</sub> = 15 V	-	54.7	-	nC
Q <sub>ge</sub>	Gate to Emitter Charge		-	9.6	-	nC
Q <sub>gc</sub>	Gate to Collector Charge		-	20.3	-	nC

## Electrical Characteristics of the Diode T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		Test Conditions		Min.	Тур.	Мах	Unit	
V <sub>FM</sub>	Diode Forward Voltage	I- =	20 A	T <sub>C</sub> = 25 <sup>o</sup> C	°C	-	2.2	2.7	V
		'F -	207	T <sub>C</sub> = 175	5°C	-	1.94	-	
E <sub>rec</sub>	Reverse Recovery Energy			T <sub>C</sub> = 175	5°C	-	50	-	uJ
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> =20 A, dI <sub>F</sub> /dt = 200 A/μs	T <sub>C</sub> = 25 <sup>o</sup>	°C		31.8	-	ns	
			T <sub>C</sub> = 175	5°C	-	192	-		
Q <sub>rr</sub>	Prr Diode Reverse Recovery Charge			T <sub>C</sub> = 25 <sup>o</sup>	°C	-	50.6	-	nC
	Didde Hororee Hobovery enalge			T <sub>C</sub> = 175	5°C	-	699	-	

## **Typical Performance Characteristics**

#### Figure 1. Typical Output Characteristics

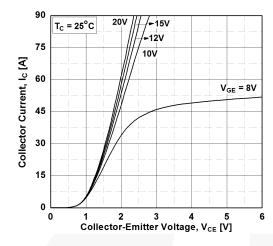


Figure 3. Typical Saturation Voltage Characteristics

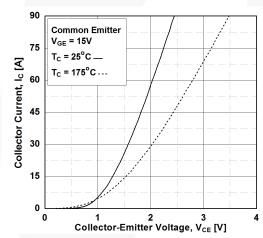


Figure 5. Saturation Voltage vs. V<sub>GE</sub>

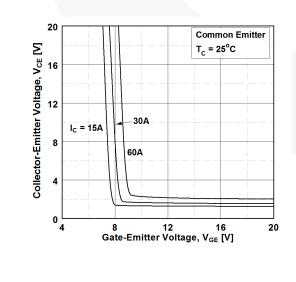
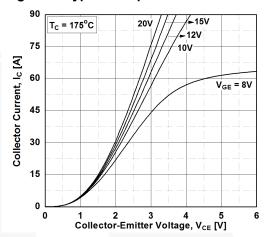


Figure 2. Typical Output Characteristics





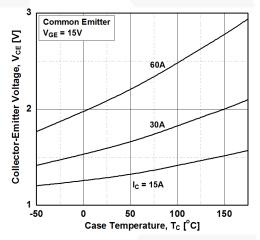
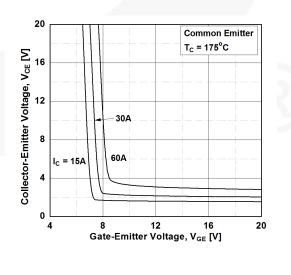
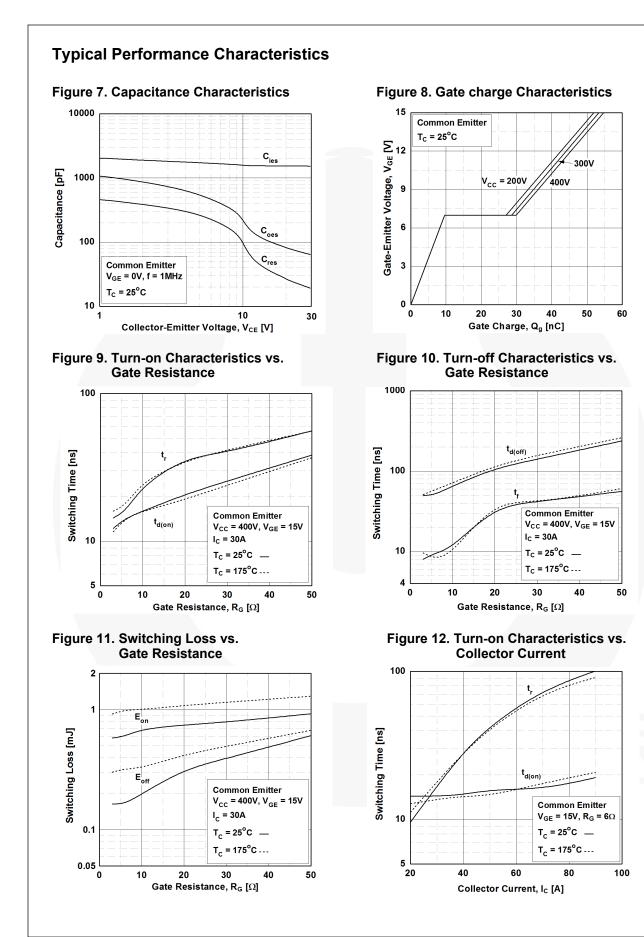
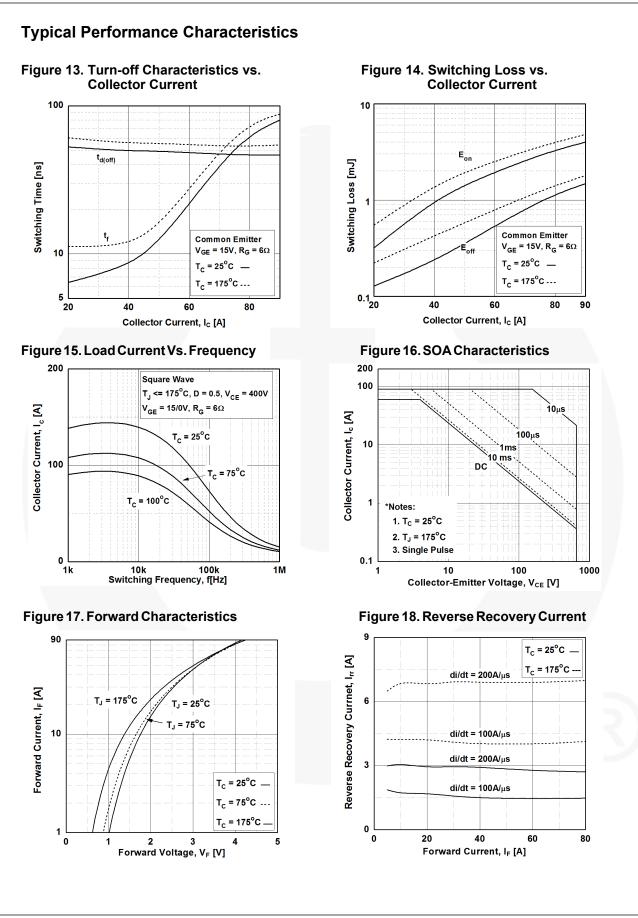


Figure 6. Saturation Voltage vs. V<sub>GE</sub>

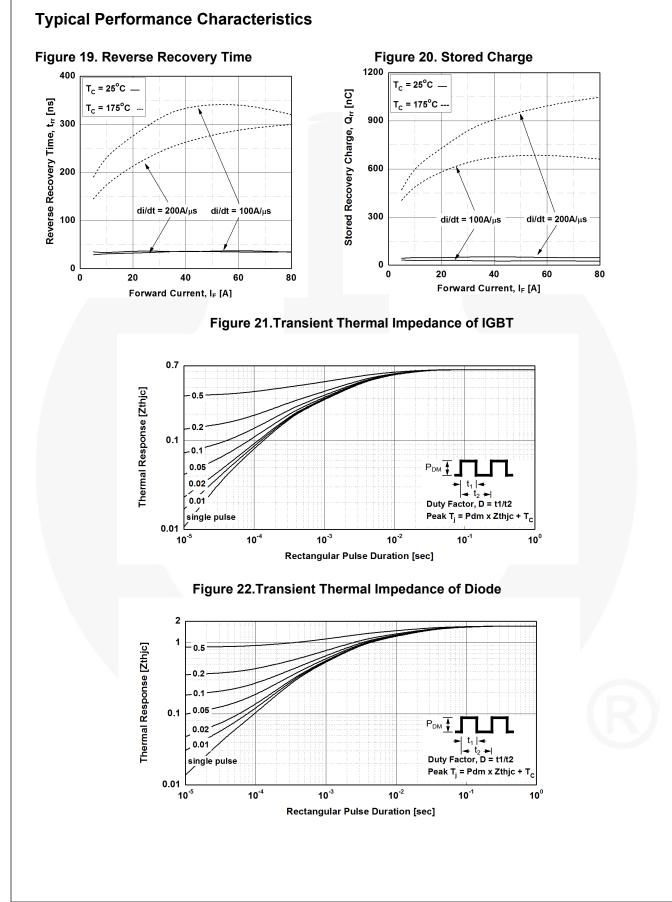


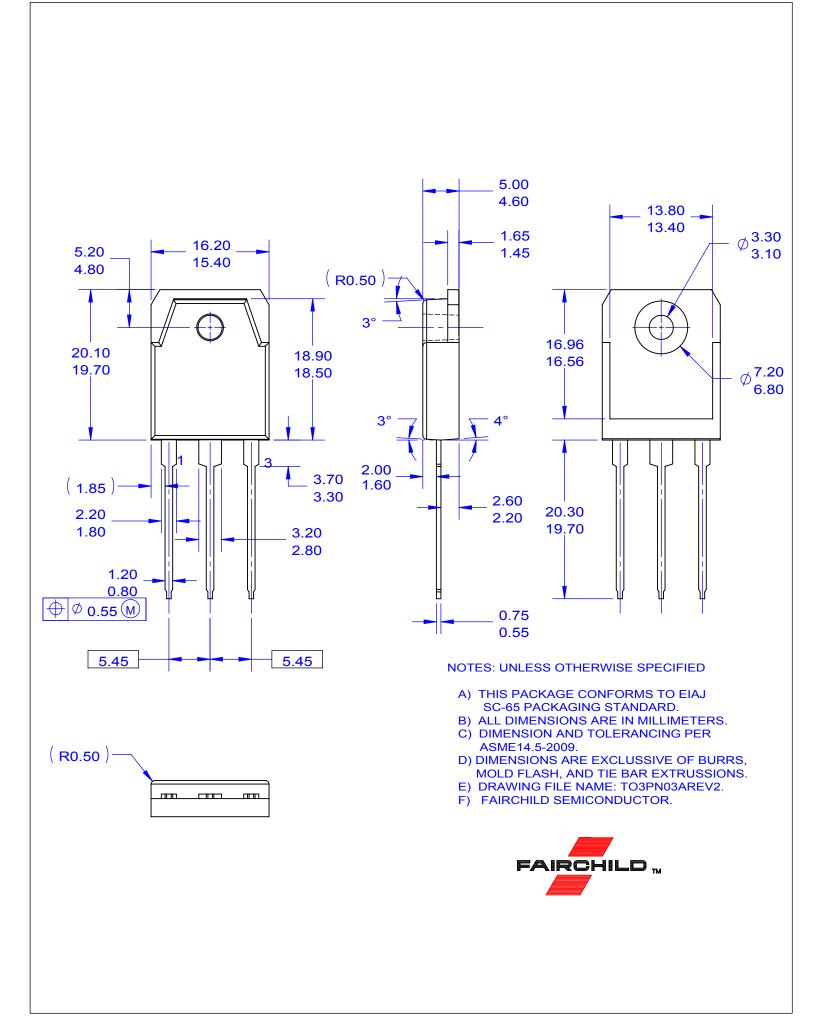


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